FORM PTO-1595 (Modified) (Rev. 6-93) OMB No. 0651-0011 (exp.4/94) Copyright 1996-97 LegalStar P08A/REV02 7.20.99 RECORI

07-29-1999



No.: FP-3426US

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

to the Honorable Commissioner of Patents and Trademarks.	riease record the attached original documents of copy thereof.		
Name of conveying party(ies): Hirotaka Makino Hajime Okada	2. Name and address of receiving party(ies): Name: Sumitomo Wiring Systems, Ltd.		
	Address: 1-14, Nishisuehiro-cho		
Additional names(s) of conveying party(ies)	- I I		
3. Nature of conveyance:			
☑ Assignment			
☐ Security Agreement ☐ Change of Name	City: Yokkaichi-City State/Prov.:		
☐ Other	Country: JAPAN ZIP: Mie 510-8503		
Execution Date: July 16, 1999	Additional name(s) & address(es) ☐ Yes ☒ No		
Application number(s) or registration numbers(s): If this document is being filed together with a new application, Patent Application No. Filing date	the execution date of the application is: July 16, 1999 B. Patent No.(s)		
5. Name and address of party to whom correspondence concerning document should be mailed:	Yes No 6. Total number of applications and patents involved:		
Name: Gerald E. Hespos	7 Total fee (37 CFR 3 /1):		
	7. Total fee (37 CFR 3.41):\$ 40.00		
1109,01101.011110	Enclosed - Any excess or insufficiency should be credited or debited to deposit account		
Address: 274 Madison Avenue - Suite 1703	☐ Authorized to be charged to deposit account		
City: New York State/Prov.: NY Country: U.S.A. ZIP: 10016	8. Deposit account number: 03-1030		
	JSE THIS SPACE		
9. Statement and signature. To the best of my knowledge and belief, the foregoing information of the original document. Gerald E. Hespos	n - // .		
Name of Person Signing	July 20, 1999 Signature Date		

Atty. Ref.: FP-3426US

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503, Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "A CONNECTOR", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee Is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patents which may be granted therefor in said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patents to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents Is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

Signed and sealed this 16 day of July , 1999.					
Hirotaka Hirotaka Maki		L.S.	Hajime Okada	Dkada.	L.S

PATENT REEL: 010122 FRAME: 0616

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